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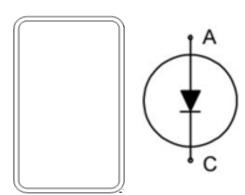
August 2016

# **PCRKA16065F8**

# 650V / 160A Extremefast Diode

### **Features**

- AEC-Q101 Qualified
- Maximum Junction Temperature 175°C
- Extremefast Technology with Soft Recovery
- Low Forward Voltage (VF = 1.4V (Typ) @IF = 160A)



# **Applications**

- Automotive Traction Modules
- General Power Modules

### **Ordering Information**

P/N	PCRKA16065F8		
Packing	Wafer (Saw-On-Foil)		
	mils	μm	
Die Size	165 X 283	4,200 X 7,200	
Anode Area	145 x 263	3,678 x 6,678	
Scribe Lane	3.14	80	
Die thickness	3 77		
Top Metal	Al (0.5% Cu)		
Back Metal	VNi/Ag		
Topside Passivation	Silicon Nitride Plus Polyimide		
Wafer diameter	200mm		
Max. Possible Die per Wafer	788		

# **Absolute Maximum Ratings** ( $T_{VJ}$ =25°C unless otherwise specified)

Symbol	Parameter	Ratings	Units
$V_{R}$	VoltageCathodetoAnode	650	V
I <sub>F</sub>	Continuous Forward Current	(Note 1)	A
T <sub>VJ</sub>	Junction Temperature Range	-55 to +175	°C
	Operating Junction Temperature	-55 to +150	°C
Tstg Storage Temperature Range		+17 to +25	°C

#### Notes

# **Electrical Characteristics of the Diode** ( $T_{VJ}$ =25°C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Static Charac	Static Characteristics (Tested on wafer)					
I <sub>R</sub>	Reverse Current	V <sub>R</sub> = 650V	-	-	30	μА
$V_{BR}$	Breakdown Voltage	I <sub>R</sub> = 1mA	650	-	-	V
V <sub>F</sub> Forward Voltage		I <sub>F</sub> = 100A	0.7	1.21	1.75	V

### **Electrical Characteristics** (Not subject to production test, verified by design /characterization)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
I <sub>R</sub>	Reverse Current	$V_R = 650V, T_{VJ} = 175^{\circ}C$	-	600	-	μΑ
\/	Forward Voltage	I <sub>F</sub> = 160A	-	1.4	1.9	V
$V_{F}$		$I_F = 160A, T_{VJ} = 175^{\circ}C$	-	1.35		V
Q <sub>rr</sub>	Reverse Recovery Charge	1 - 4004 \/ - 400\/	-	3.3	-	μС
I <sub>rr</sub>	Reverse Recovery Current	I <sub>F</sub> = 160A, V <sub>R</sub> = 400V,   dI <sub>F</sub> /dt = 1000A/μs, T <sub>VJ</sub> =   25°C	-	50		Α
T <sub>rr</sub>	Reverse Recovery Time	20 0	-	132	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	L = 160A \/ = 400\/	-	12.5	-	μС
I <sub>rr</sub>	Reverse Recovery Current	- I <sub>F</sub> = 160A, V <sub>R</sub> = 400V, dI <sub>F</sub> /dt = 1000A/μs, T <sub>VJ</sub> = - 175°C	-	101.7		Α
T <sub>rr</sub>	Reverse Recovery Time	_ 173 0	-	245	-	ns

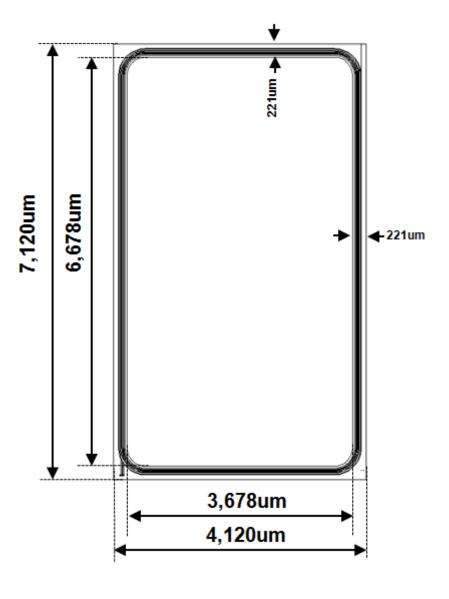
For ordering, technique and other information on Fairchild automotive bare die products, please contact  $\underline{automotive die@fairchildsemi.com}$ 

<sup>1:</sup> Depends on the thermal properties of assembly



August 2016

## **Physical Dimensions**







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